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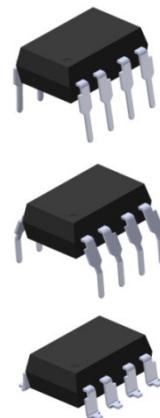
Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

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Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLER****EL3120****Features:**

- Guaranteed performance from -40 to 100°C
- Peak Output Current :  $I_{OP} = \pm 2.5A$  (max)
- Threshold Input Current:  $I_{FLH} = 5\text{ mA}$  (max)
- Common mode transient immunity :  $\pm 15\text{ kV}/\mu\text{s}$  ( min )
- High isolation voltage between input and output (Viso=5000 V rms )
- Pb free and RoHS compliant.
- cUL approved (E214129)
- VDE approved (40028391)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved

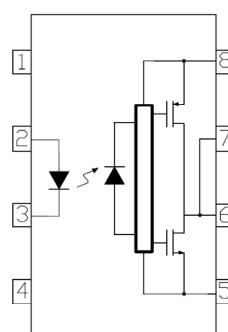
**Description**

The EL3120 consists of an infrared light emitting diodes and integrated high gain, high-speed photo detectors. The device is housed in a 8 pin DIP package.

The photo detector has an internal shield that provides a guaranteed common-mode transient immunity of  $\pm 15\text{ kV}/\mu\text{s}$ . It is suitable for direct gate driving circuit for IGBTs or power MOSFETs.

**Applications**

- Isolated IGBT/Power MOSFET gate drive
- Industrial Inverter
- AC brushless and DC motor drives
- Inverter for home appliances

**Truth Table****Schematic****Pin Configuration**

- 1, NC
- 2, Anode
- 3, Cathode
- 4, NC
- 5,  $V_{EE}$
- 6,  $V_{O2}$
- 7,  $V_{O1}$
- 8,  $V_{CC}$

Input	$V_{CC}-V_{EE}$	$V_{CC}-V_{EE}$	Output
	Positive Going	Negative Going	
L	0 to 30 V	0 to 30V	L
H	0 to 11.5V	0 to 10V	L
H	11.5 to 13.5V	10 to 12V	Transition
H	13.5 to 30V	12 to 30V	H

# 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

### EL3120

#### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ )

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	25	mA
	Pulse Forward Current <sup>*1</sup>	$I_{FP}$	1	A
	Reverse voltage	$V_R$	5	V
Output	"H" Peak Output current <sup>*2</sup>	$I_{OPH}$	3	A
	"L" Peak Output Current <sup>*2</sup>	$I_{OPL}$	3	A
	Peak Output Voltage	$V_O$	35	V
	Supply Voltage	$V_{CC} - V_{EE}$	0 to 35	V
	Power Dissipation	$P_C$	250	mW
Operating frequency <sup>*3</sup>		f	50	kHz
Isolation voltage <sup>*4</sup>		$V_{ISO}$	5000	V rms
Total Power Dissipation		$P_T$	300	mW
Operating temperature		$T_{OPR}$	-40 ~ +100	°C
Storage temperature		$T_{STG}$	-55 ~ +125	°C
Soldering temperature <sup>*5</sup>		$T_{SOL}$	260	°C

#### Notes

\*1 Pulse width  $\leq 1 \mu\text{s}$ , 300pps.

\*2 Max. pulse width=10us, max. duty cycle =1.1%

\*3 Exponential waveform pulse width  $P_W \leq 0.3\mu\text{s}$ ,  $I_{OPH} \geq 2.5\text{A}$ ,  $I_{OPL} \leq 2.5\text{A}$ ,

\*4 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 to 4 are shorted together, and pins 5 to 8 are shorted together.

\*5 For 10 seconds.

## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLER

EL3120

### Electrical Characteristics

Apply over all recommended condition, typical value is measured at  $V_{CC}=30V$ ,  $V_{EE}=\text{ground}$ ,  $T_A=25^\circ\text{C}$  unless specified otherwise.

#### Input

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Forward voltage	$V_F$	-	1.4	1.8	V	$I_F = 10\text{mA}$
Reverse voltage	$V_R$	5.0	-	-	V	$I_R = 10\mu\text{A}$
Temperature coefficient of forward voltage	$\Delta V_F/\Delta T_A$	-	-1.9	-	mV/°C	$I_F = 10\text{mA}$
Input capacitance	$C_{IN}$	-	60	-	pF	$V_F=0, f=1\text{MHz}$

#### Output

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
High level supply current	$I_{CCH}$	-	1.65	3.8	mA	$I_F=7 \text{ to } 10\text{mA}, V_O=\text{Open}$
Low level supply current	$I_{CCL}$	-	1.55	3.8		$V_F=0 \text{ to } 0.8\text{V}, V_O=\text{Open}$

### Transfer Characteristics

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
High Level Output Current <sup>*6</sup>	$I_{OH}$	-1	-	-	A	$V_O=V_{CC}-3\text{V}$
		-2	-	-		$V_O=V_{CC}-6\text{V}$
Low Level Output Current <sup>*6</sup>	$I_{OL}$	1	-	-	A	$V_O=V_{EE}+3\text{V}$
		2	-	-		$V_O=V_{EE}+6\text{V}$
High Level Output Voltage	$V_{OH}$	$V_{CC}-6.25$	-	-	V	$I_F=10\text{mA}, I_O=-2.5\text{A}$
		$V_{CC}-0.25$	-	-		$I_F=10\text{mA}, I_O=-100\text{mA}$
Low Level Output Voltage	$V_{OL}$	-	-	$V_{EE}+6.25$	V	$I_F=0\text{mA}, I_O=2.5\text{A}$
		-	-	$V_{EE}+0.25$		$I_F=0\text{mA}, I_O=100\text{mA}$
Input Threshold Current	$I_{FLH}$	-	2.3	5	mA	$I_O=0\text{mA}, V_O > 5\text{V}$
Input Threshold Voltage	$V_{FHL}$	0.8	-	-	V	$I_O=0\text{mA}, V_O < 5\text{V}$
Under Voltage Lockout Threshold	$V_{UVLO+}$	11.5	-	13.5	V	$I_F=10\text{mA}, V_O > 5\text{V}$
Under Voltage Lockout Threshold	$V_{UVLO-}$	10.0	-	12.0	V	$I_F=10\text{mA}, V_O < 5\text{V}$

# 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

### EL3120

#### Switching Characteristics

Apply over all recommended condition, typical value is measured at  $V_{CC}=30V$ ,  $V_{EE}=\text{ground}$ ,  $T_A=25^\circ\text{C}$  unless specified otherwise.

Parameter	Symbol	Min.	Typ.*	Max.	Unit	Condition
Propagation delay time to output High level	$t_{PLH}$	150	200	300	ns	$I_F = 7 \text{ to } 16\text{mA}$ $C_L = 10\text{nF}$ , $R_L = 10\Omega$ , $f = 10\text{kHz}$ , Duty = 50%, $T_A = 25^\circ\text{C}$
Propagation delay time to output Low level	$t_{PHL}$	120	170	300	ns	
Pulse width distortion	$ t_{PHL} - t_{PLH} $	-	30	100	ns	
Propagation Delay Skew <sup>*7</sup>	$t_{PSK}$	-	-	40	ns	
Output rise time	$t_r$	-	60	-	ns	
Output fall time	$t_f$	-	60	-	ns	
UVLO Turn on Delay	$t_{UVLO\ O_N}$		30		us	$I_F = 10\text{mA}$ , $V_O > 5\text{V}$
UVLO Turn off Delay	$t_{UVLO\ O_{FF}}$		0.4		us	$I_F = 10\text{mA}$ , $V_O < 5\text{V}$
Common Mode Transient Immunity at Logic High <sup>*8</sup>	$CM_H$	-15	-	-	kV/ $\mu\text{s}$	$I_F = 7 \text{ to } 16\text{mA}$ , $V_{CC} = 30\text{V}$ , $R_L = 350\Omega$ , $T_A = 25^\circ\text{C}$ $V_{CM} = 2\text{kV}$
Common Mode Transient Immunity at Logic Low <sup>*9</sup>	$CM_L$	15	-	-	kV/ $\mu\text{s}$	$V_F = 0\text{V}$ , $V_{CC} = 30\text{V}$ , $R_L = 350\Omega$ , $T_A = 25^\circ\text{C}$ $V_{CM} = 2\text{kV}$

#### Notes:

\*6 Max. pulse width=10us, max. duty cycle =1.1%

\*7 Propagation delay skew is defined as the difference between the largest and smallest propagation delay times (i.e.  $t_{PHL}$  or  $t_{PLH}$ ) of multiple samples. Evaluations of these samples are conducted under identical test conditions (supply voltage, input current, temperature, etc).

\*8 Common mode transient immunity at output high is the maximum tolerable negative dv/dt on the trailing edge of the common mode impulse signal,  $V_{CM}$ , to assure that the output will remain high (i.e.  $V_O > 15.0\text{V}$ )

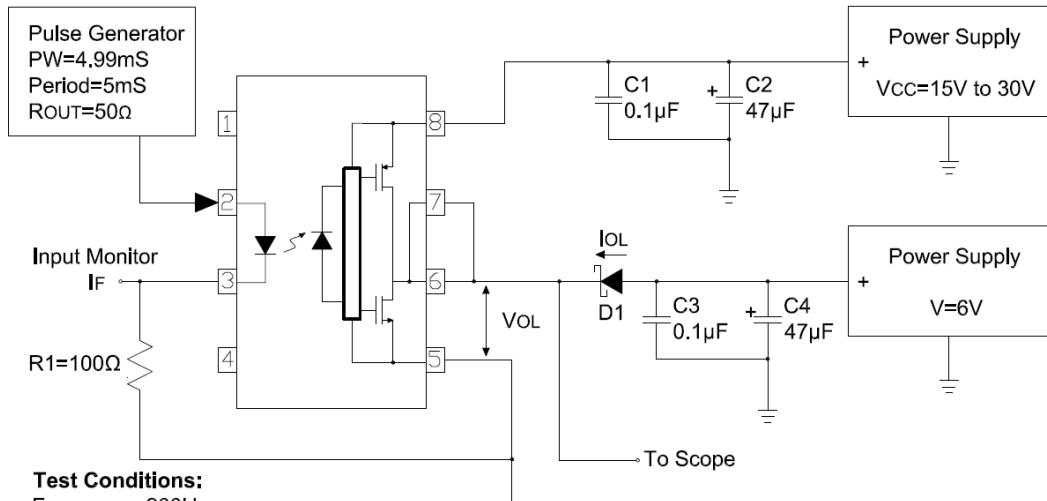
\*9 Common mode transient immunity at output low is the maximum tolerable positive dv/dt on the leading edge of the common mode pulse signal,  $V_{CM}$ , to assure that the output will remain low (i.e.  $V_O < 1.0\text{V}$ )

## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

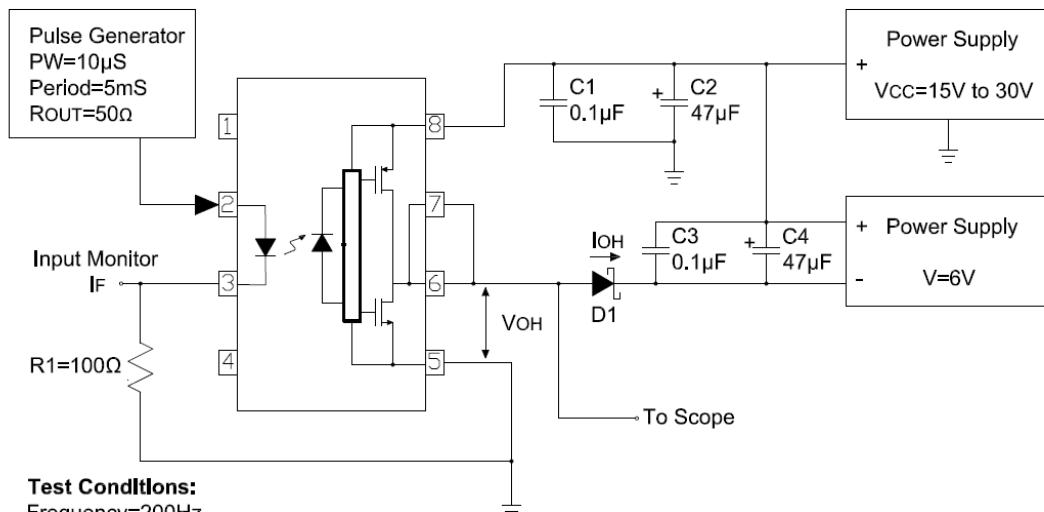
EL3120

### Test Circuit



**Test Conditions:**  
 Frequency=200Hz  
 Duty Cycle=99.8%  
 VCC=15V to 30V  
 VEE=0V  
 VF(OFF)= -3.0V to 0.8V

### I<sub>OL</sub> Test Circuit

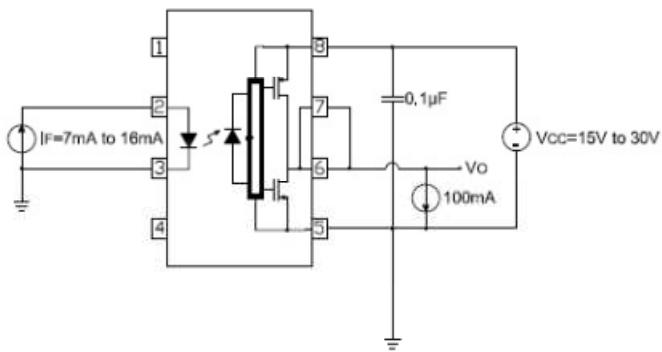


**Test Conditions:**  
 Frequency=200Hz  
 Duty Cycle=0.2%  
 VCC=15V to 30V  
 VEE=0V  
 IF=7mA to 16mA

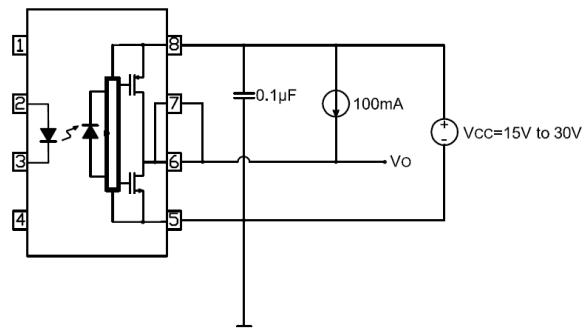
### I<sub>OH</sub> Test Circuit

# 8PIN DIP IGBT/MOSFET 2.5A Output Current GATE DRIVER PHOTOCOUPLED

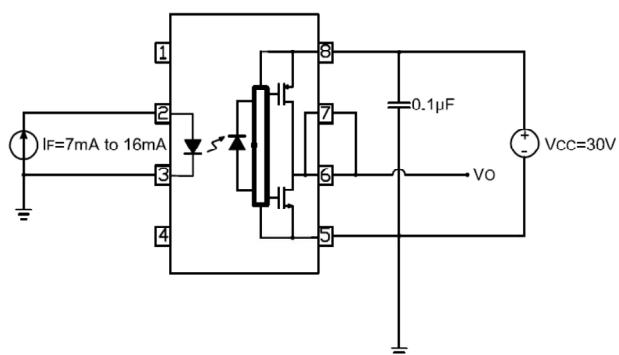
EL3120



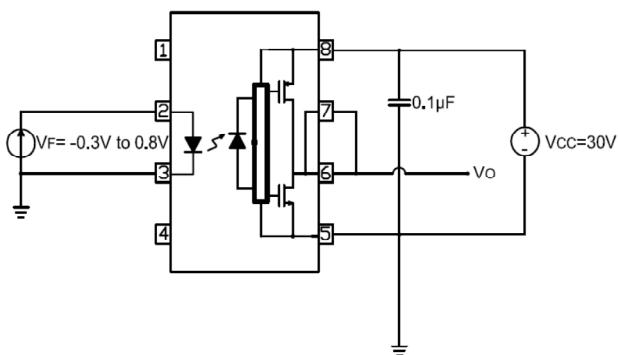
$V_{OH}$  Test Circuit



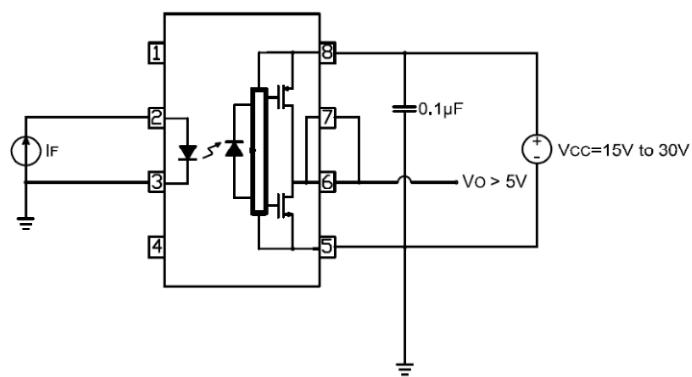
$V_{OL}$  Test Circuit



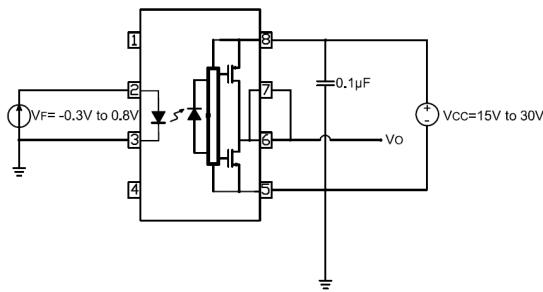
$I_{CCH}$  Test Circuit



$I_{CCL}$  Test Circuit



$I_{FLH}$  Test Circuit

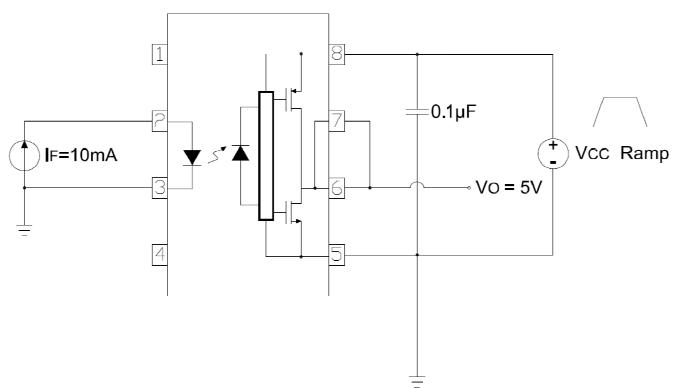


$V_{FHL}$  Test Circuit

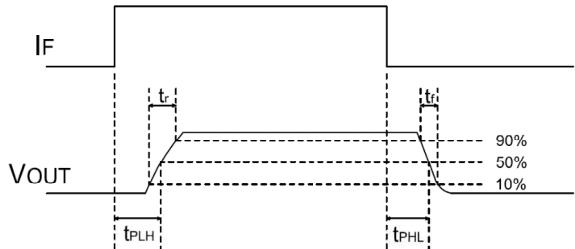
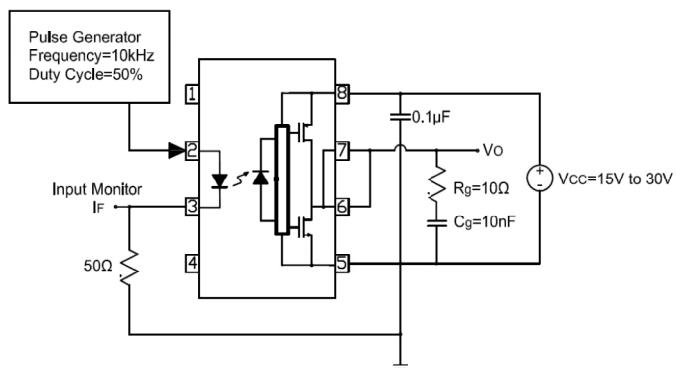
## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLER

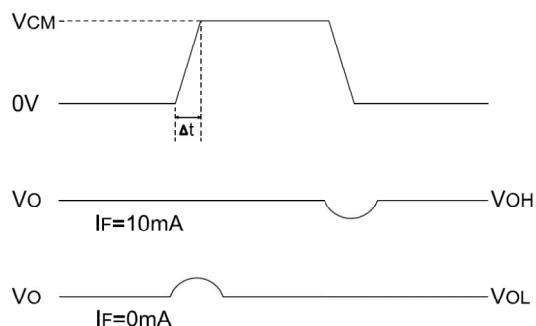
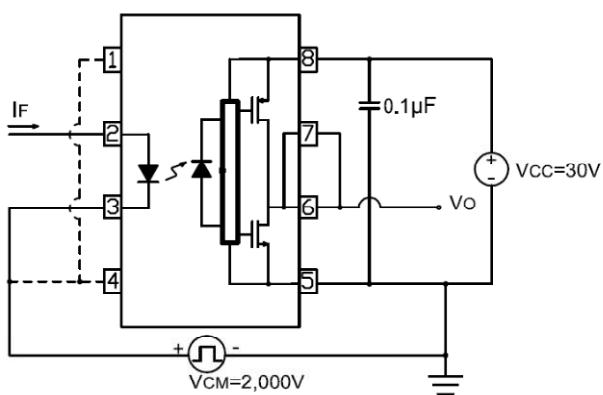
EL3120



**UVLO Test Circuit**



**$t_{PHL}$ ,  $t_{PLH}$ ,  $t_r$  and  $t_f$  Test Circuit and Waveforms**



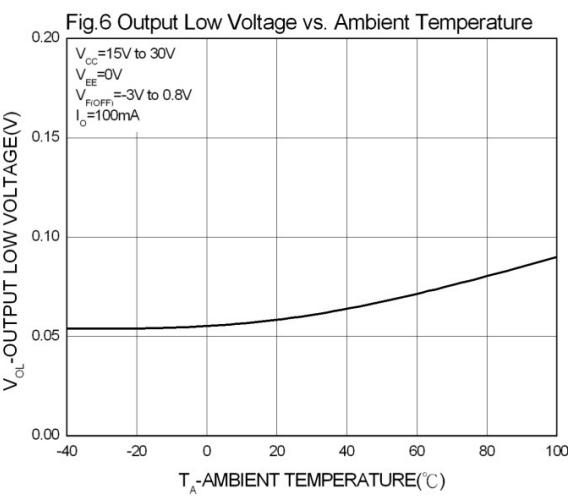
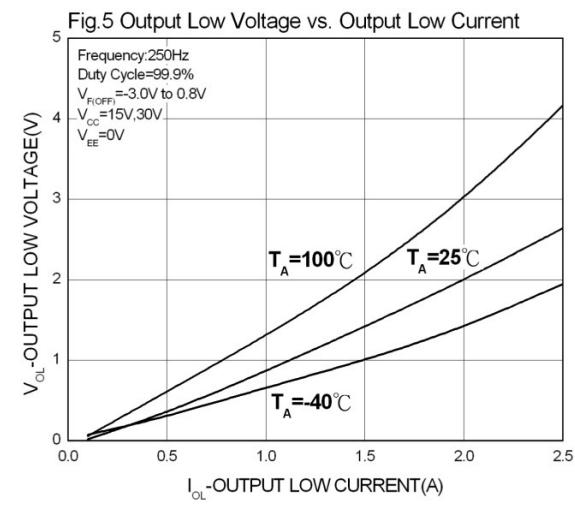
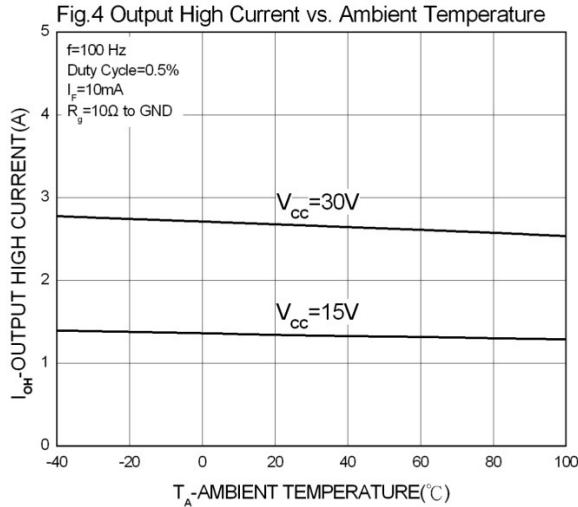
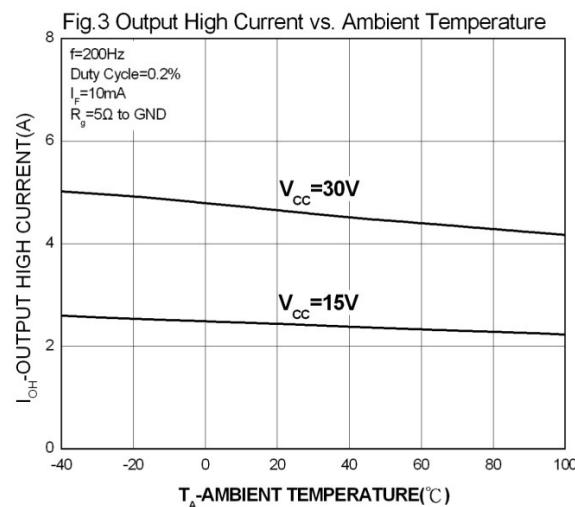
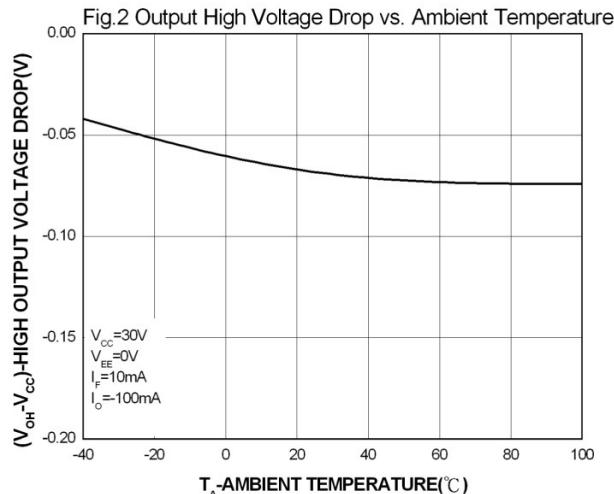
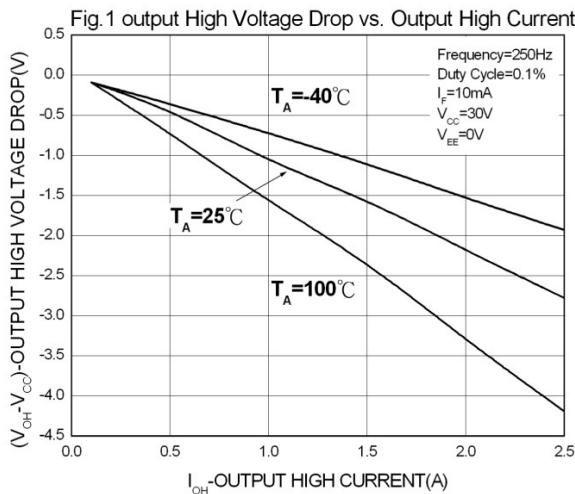
**CMR Test Circuit and Waveforms**

## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

EL3120

### Typical Performance Curves



## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

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Fig.7 Output Low Current vs. Ambient Temperature

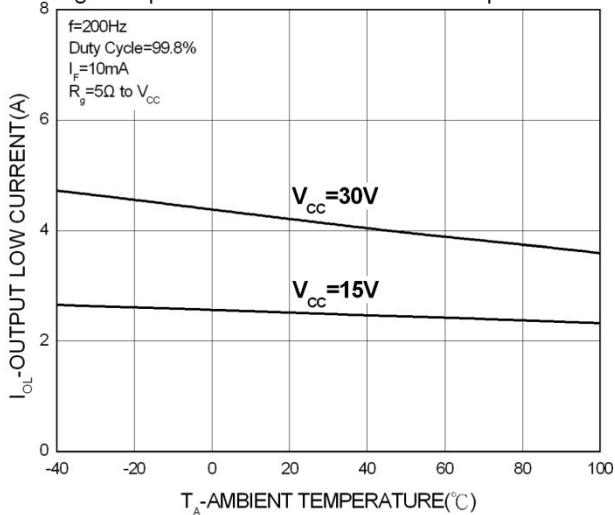


Fig.8 Output Low Current vs. Ambient Temperature

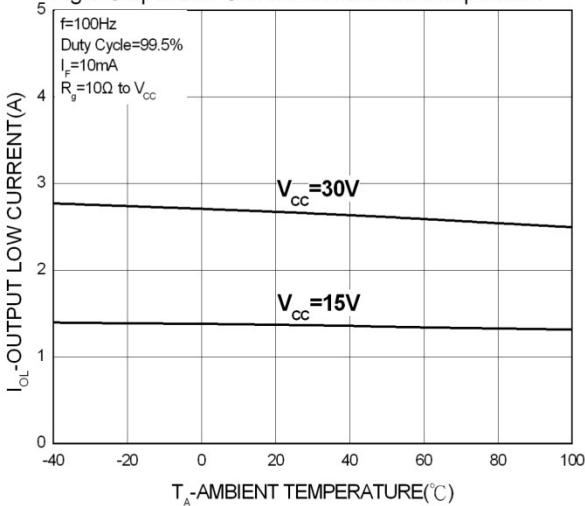


Fig.9 Supply Current vs. Ambient Temperature

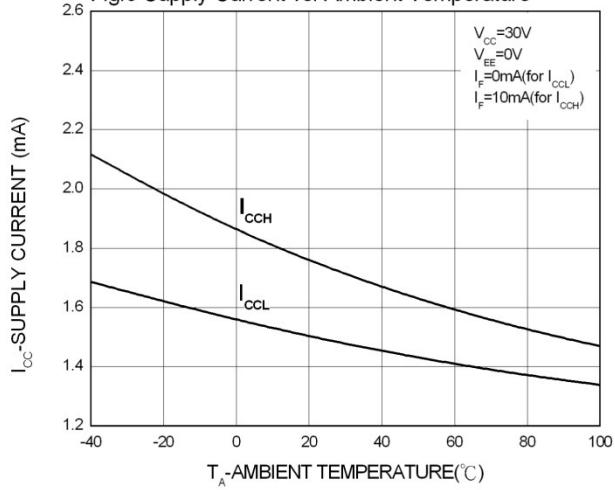


Fig.10 Supply Current vs. Supply voltage

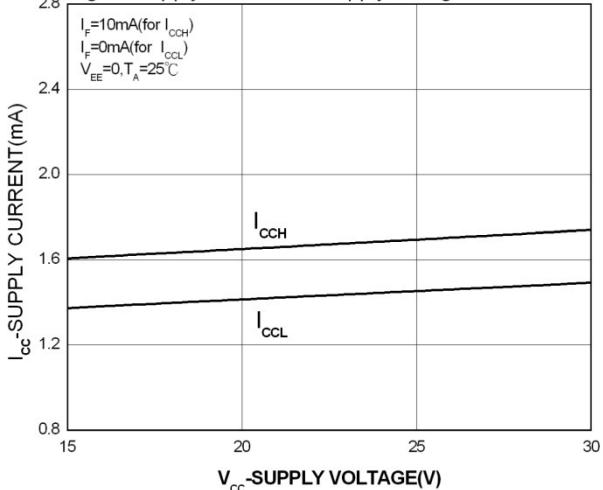


Fig.11 Low to High Input Current Threshold vs. Ambient Temperature

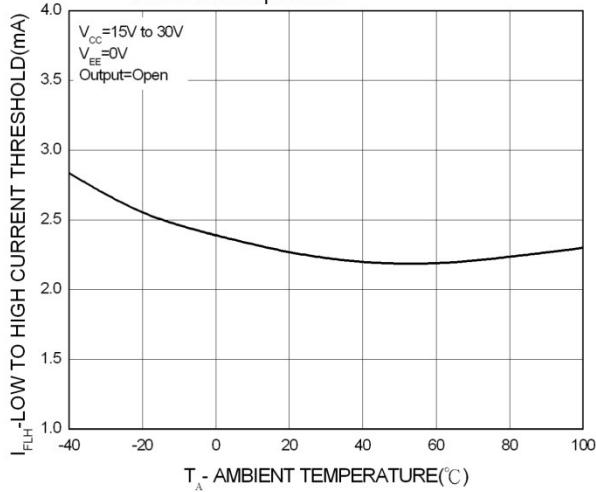
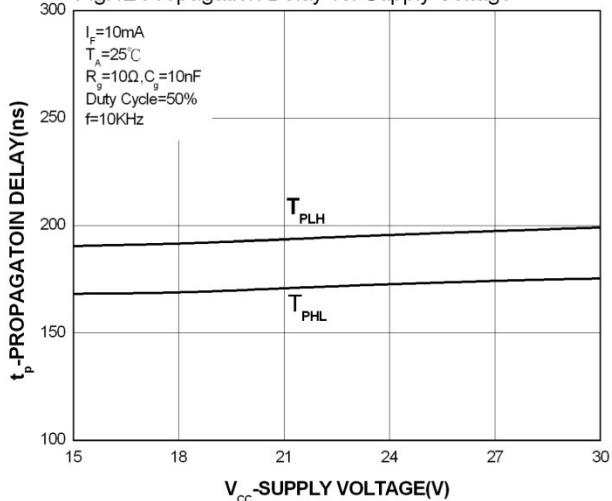


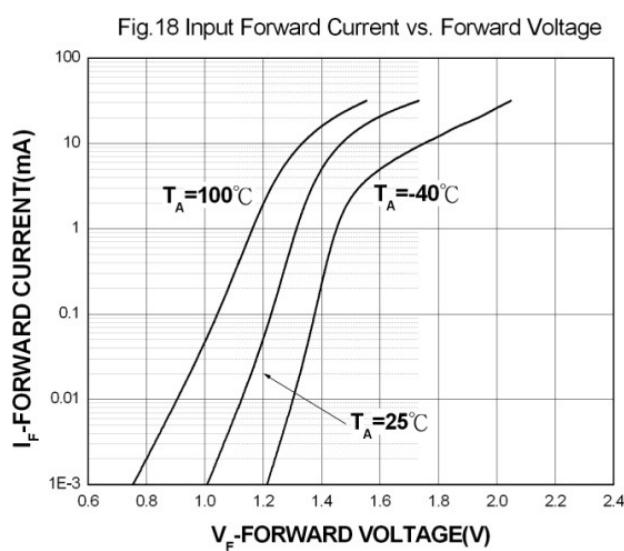
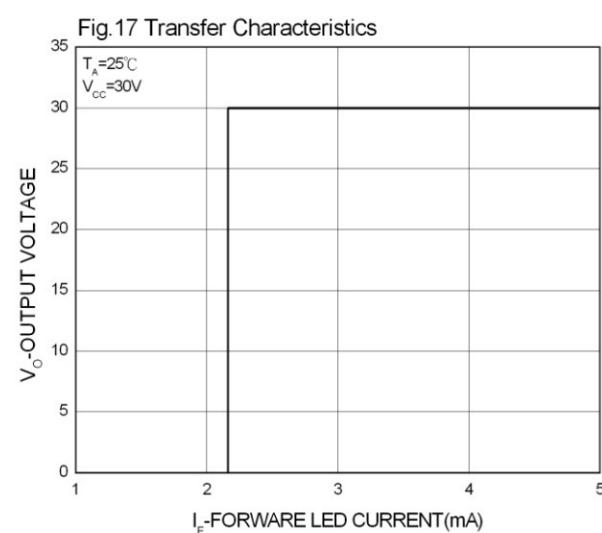
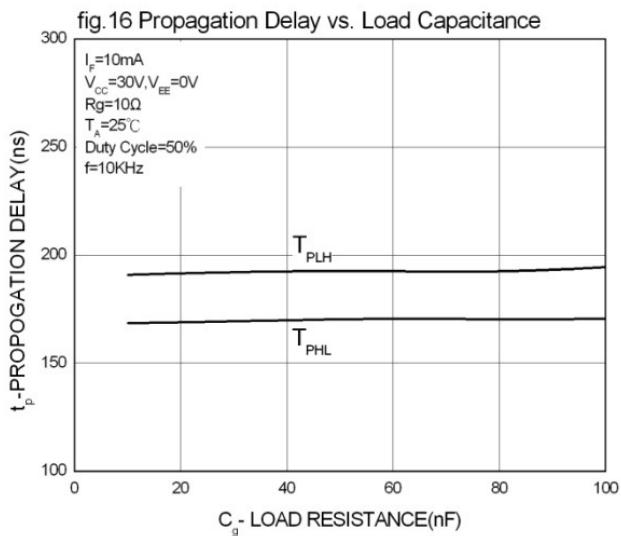
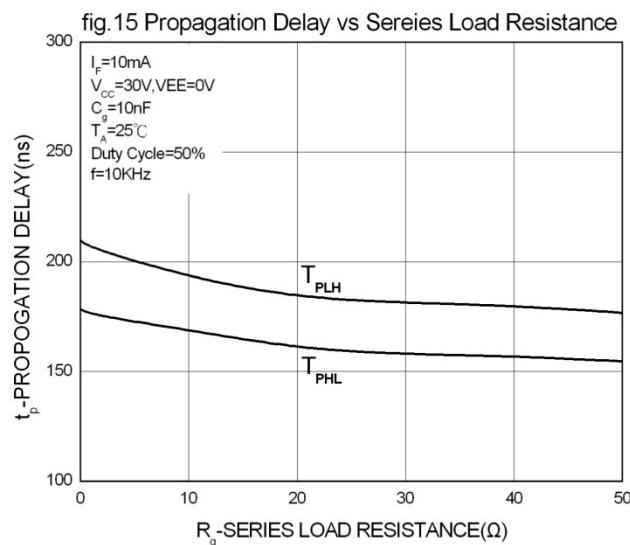
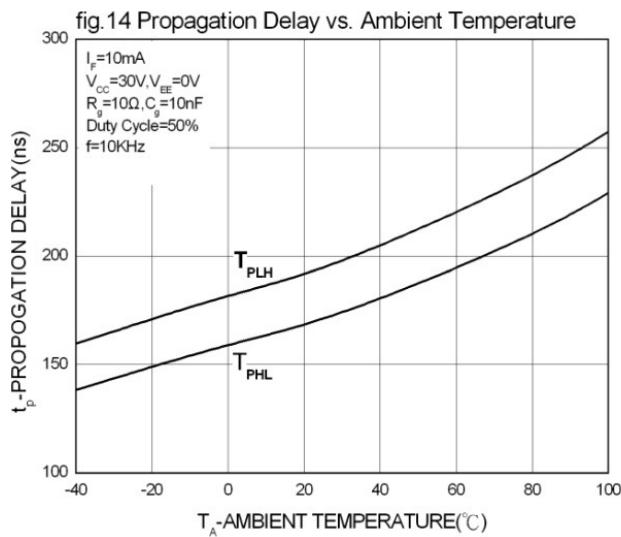
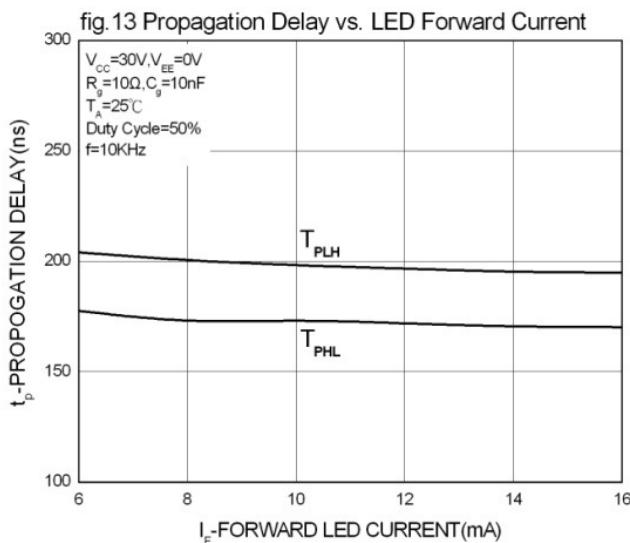
Fig.12 Propagation Delay vs. Supply Voltage

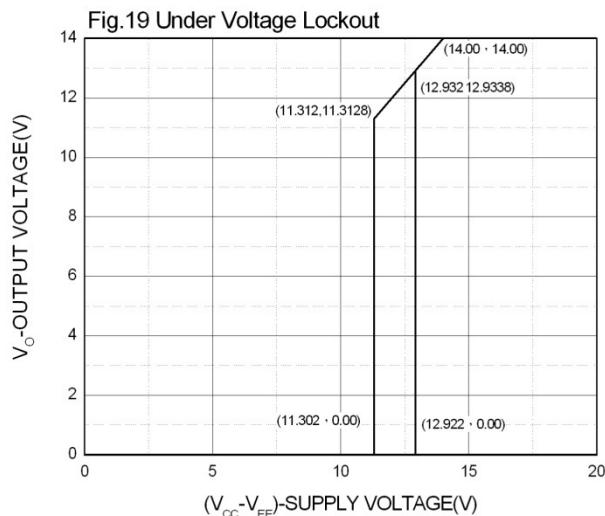


## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLED

EL3120



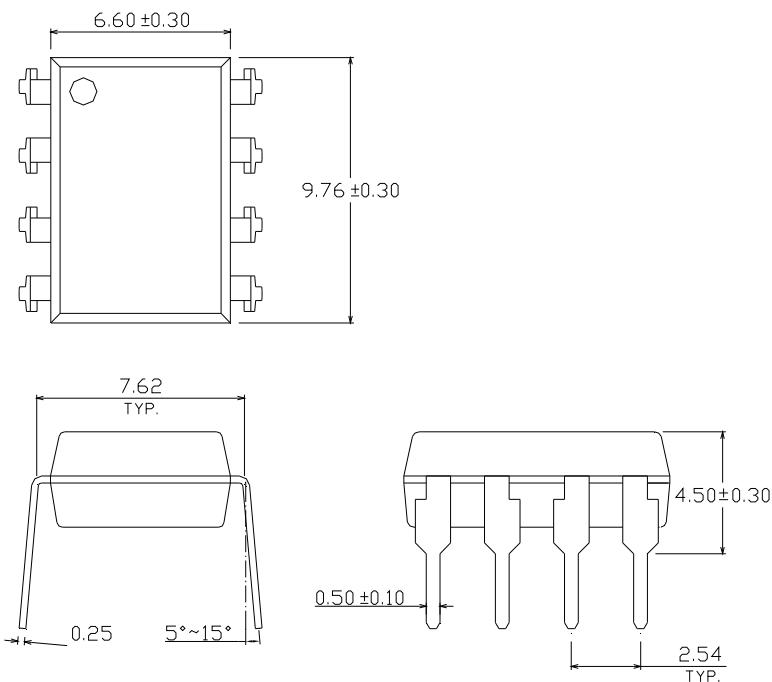
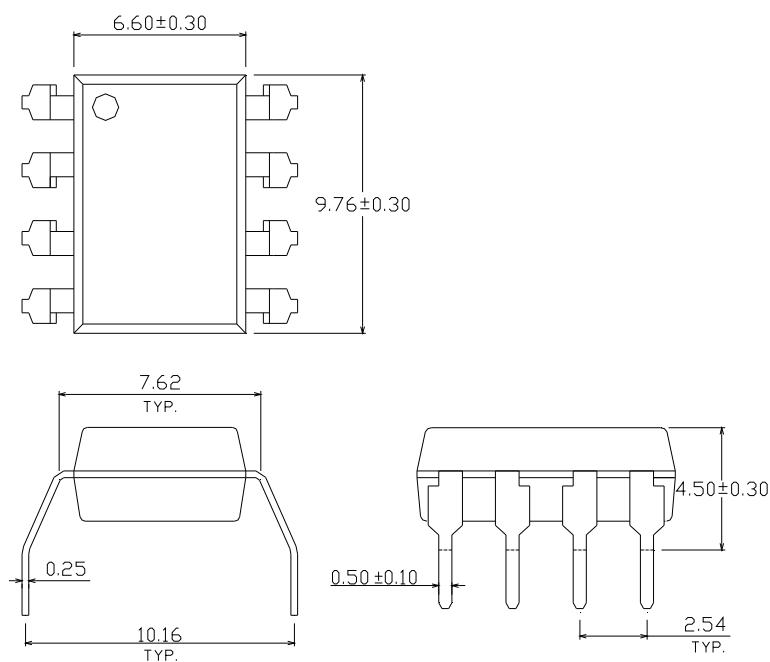
**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLER****EL3120****Order Information****Part Number****EL3120Y(Z)-V****Note**

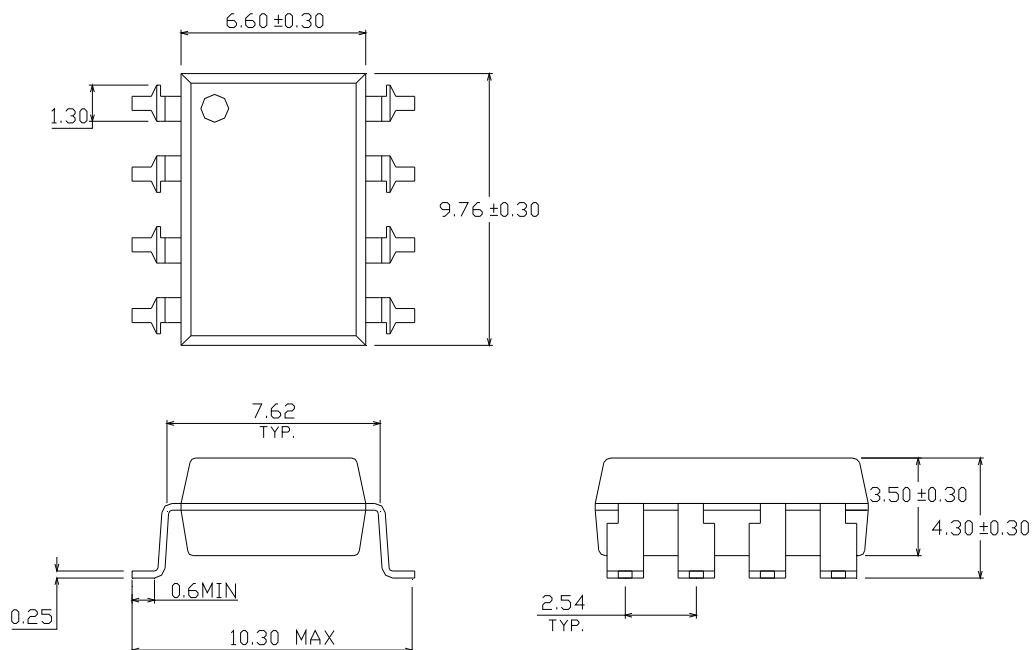
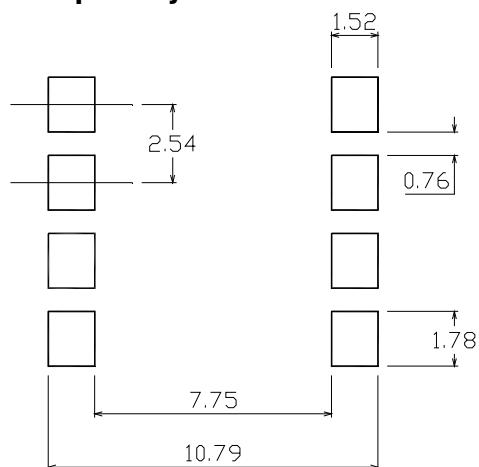
- Y = Lead form option (S, M or none)  
Z = Tape and reel option (TA, TB or none).  
V = VDE (optional)

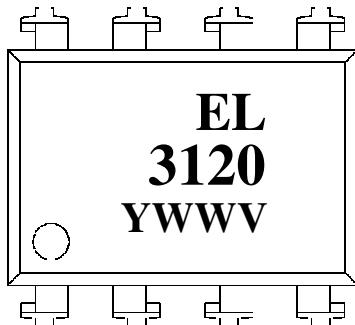
Option	Description	Packing quantity
None	Standard	45 units per tube
M	Wide lead bend (0.4 inch spacing)	45 units per tube
(TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
(TB)	Surface mount lead form + TB tape & reel option	1000 units per reel

**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLER****EL3120****Package Drawing**

(Dimensions in mm)

**Standard DIP Type****Option M Type**

**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLER****EL3120****Option S Type****Recommended pad layout for surface mount leadform**

**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLER****EL3120****Device Marking****Notes**

- 3120      denotes Device Number  
Y            denotes 1 digit Year code  
WW          denotes 2 digit Week code  
V            denotes VDE (optional)

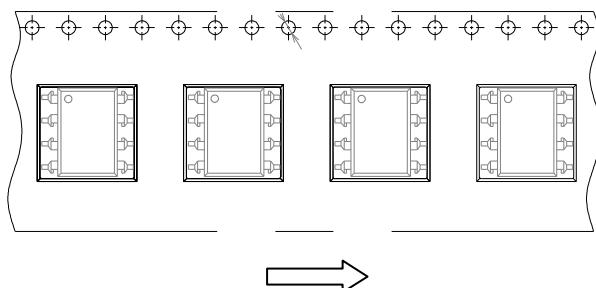
## 8PIN DIP IGBT/MOSFET

## 2.5A Output Current GATE DRIVER PHOTOCOUPLER

**EL3120**

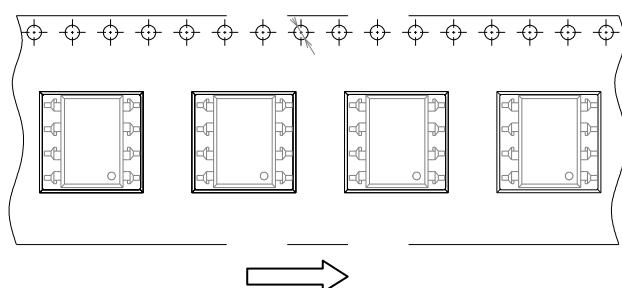
### Tape & Reel Packing Specifications

Option TA



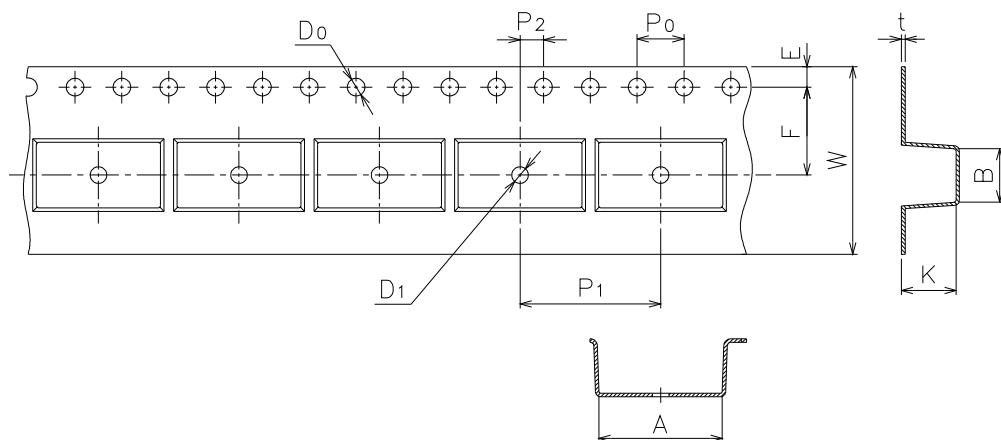
Direction of feed from reel

Option TB

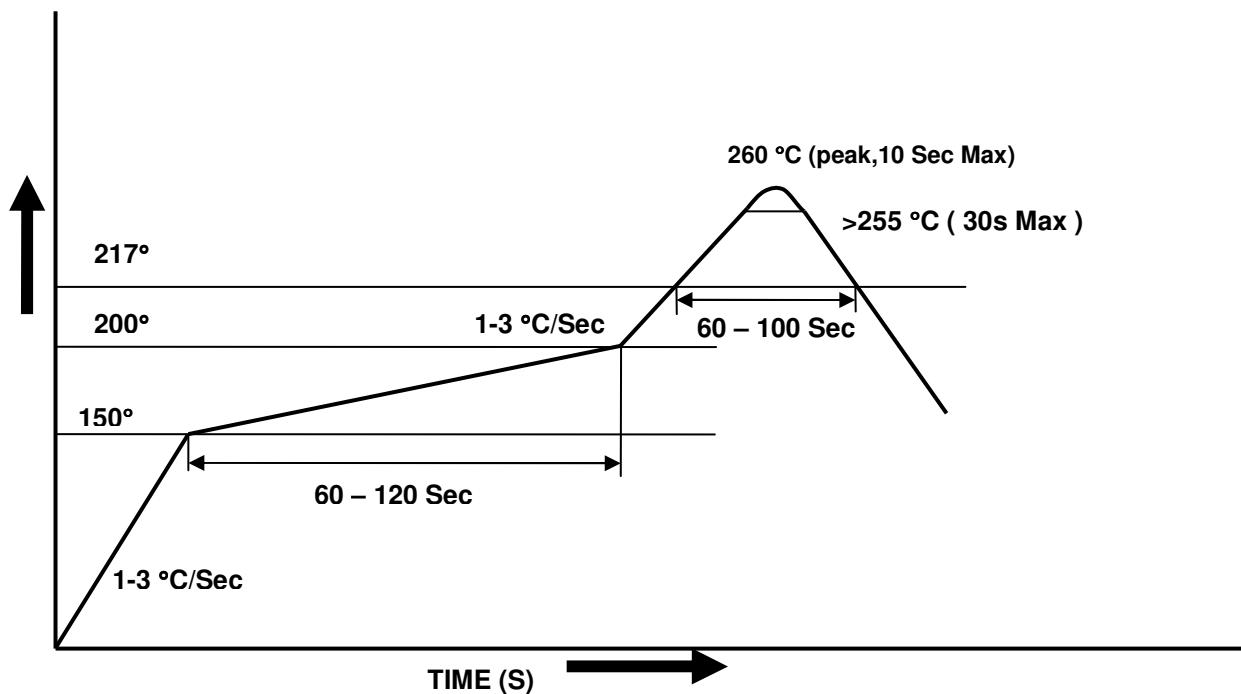


Direction of feed from reel

### Tape dimensions



Dimension No.	A	B	D <sub>0</sub>	D <sub>1</sub>	E	F
Dimension(mm)	10.4±0.1	10.0±0.1	1.5±0.1	1.5±0.1	1.75±0.1	7.5±0.1
Dimension No.	P <sub>0</sub>	P <sub>1</sub>	P <sub>2</sub>	t	W	K
Dimension(mm)	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0+0.3/-0.1	4.5±0.1

**8PIN DIP IGBT/MOSFET****2.5A Output Current GATE DRIVER PHOTOCOUPLED****EL3120****Solder Reflow Temperature Profile**

**DISCLAIMER**

1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
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